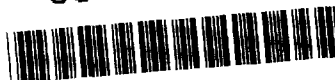




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Case Docket No. 000407

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To the Assistant Commissioner for Patents  
Please record the attached original documents or copy thereof.

1. Name of conveying party:

Shunji NAKAMURA

Additional name(s) of conveying party attached? Yes ☐ No ☒ XX

2. Name and address of receiving party:

Name: FUJITSU LIMITED

Street Address:

1-1, Kamikodanaka 4-chome, Nakahara-ku,  
Kawasaki-shi, Kanagawa 211-8588, JapanAdditional name(s) & address(es) attached? Yes ☐ No ☒ XX

3. Nature of conveyance: Assignment

Execution Date: June 20, 2000

4. Title: SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE  
SAME

5. Application number(s) or patent number(s):

A. Patent Application No.(s)

09/537,434

B. Patent No.(s)

If this document is being filed together with a new application, the execution date of the  
application is: \_\_\_\_\_Additional numbers attached? Yes ☐ No ☒ XX

07/31/2000 MTHAI1 00000162 09537434

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40.00 DP

6. Name and address of party to whom correspondence concerning document should be mailed:

Name: ARMSTRONG, WESTERMAN, HATTORI,  
MCLELAND & NAUGHTON  
1725 K Street, N.W., Suite 1000  
Washington, D.C. 20006

7. Total number of applications and patents involved: 1

8. Total fee (37 CFR 3.41). . . . . \$40.00

XX Enclosed

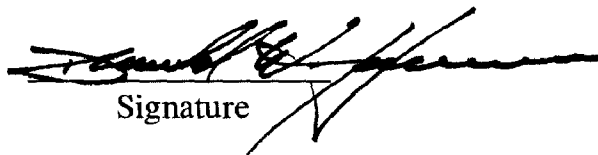
    Authorized to be charged to Deposit Account

9. Deposit Account No.: **01-2340**

10. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Donald W. Hanson  
Name of Person Signing

  
Signature

July 5, 2000  
Date

27,133  
Registration No.

Total number of pages including cover sheet, attachments and document: 3

DWH/llf  
Rev. 2/97

**U.S. ASSIGNMENT**

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

(Insert ASSIGNEE's  
Name(s) Address(es))

FUJITSU LIMITED  
1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi,  
Kanagawa 211-8588 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

(\*If the assignment is  
being filed after the filing  
of the application, this  
section must be  
completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

\*filed on March 27, 2000, Serial No. 09/537,434.  
(Armstrong, Westerman, Hattori, McLeland & Naughton is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

|                                       |                                       |                                |
|---------------------------------------|---------------------------------------|--------------------------------|
| <u>Shunji Nakamura</u><br>(SIGNATURE) | <u>Shunji Nakamura</u><br>(TYPE NAME) | <u>June 20, 2000</u><br>(DATE) |
| _____<br>(SIGNATURE)                  | _____<br>(TYPE NAME)                  | _____<br>(DATE)                |
| _____<br>(SIGNATURE)                  | _____<br>(TYPE NAME)                  | _____<br>(DATE)                |
| _____<br>(SIGNATURE)                  | _____<br>(TYPE NAME)                  | _____<br>(DATE)                |
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| _____<br>(SIGNATURE)                  | _____<br>(TYPE NAME)                  | _____<br>(DATE)                |
| _____<br>(SIGNATURE)                  | _____<br>(TYPE NAME)                  | _____<br>(DATE)                |

NO LEGALIZATION REQUIRED